

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2838995

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TIMOTHY D. HENSON	04/23/2014
KAPIL KELKAR	04/23/2014
LJUBO RADIC	04/21/2014
RECEIVING PARTY DATA	
Name:	International Rectifier Corporation
Street Address:	101 N. Sepulveda Blvd.
City:	El Segundo
State/Country:	CALIFORNIA
Postal Code:	90245
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14267760
CORRESPONDENCE DATA	
Fax Number:	(949)282-1002
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	MICHAEL FARJAMI
Address Line 1:	26522 LA ALAMEDA AVE., SUITE 360
Address Line 4:	MISSION VIEJO, CALIFORNIA 92691
ATTORNEY DOCKET NUMBER:	0400787
NAME OF SUBMITTER:	MICHAEL FARJAMI
SIGNATURE:	/MF/
DATE SIGNED:	05/01/2014
Total Attachments: 4	
source=0400787 Assignment for 14 267,760#page1.tif	
source=0400787 Assignment for 14 267,760#page2.tif	
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source=0400787 Assignment for 14 267,760#page4.tif	

ASSIGNMENT

WHEREAS, I/WE:

INVENTOR NAME	INVENTOR RESIDENCE ADDRESS
Timothy D. Henson	2003 Gramercy Ave.; Torrance, CA 90501
Kapil Kelkar	2740 Gramercy Ave., Unit#10; Torrance, CA 90501
Ljubo Radic	2029 W 182nd St.; Torrance, CA 90504

have invented certain new and useful improvements disclosed in an application for United States Letters Patent titled "SEMICONDUCTOR DEVICE WITH A FIELD PLATE TRENCH HAVING A THICK BOTTOM DIELECTRIC," filed herewith, or filed on 05/01/2014, Serial No. 14/267,760, and identified by Docket No. 0400787 in the offices of FARJAMI & FARJAMI LLP;

AND WHEREAS INTERNATIONAL RECTIFIER CORPORATION, a Delaware corporation (hereinafter, together with any successors, legal representatives and assigns thereof, called "Assignee"), wants to acquire the entire right, title, and interest in and to said improvements and application:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I/WE have sold, assigned, transferred and set over, and do hereby sell, assign, transfer and set over to Assignee the entire right, title, and interest in and to said improvements, and said application and all divisions, substitutions, continuations and continuations-in-part thereof, and all United States Letters Patents which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every member country, and all applications for patents (including related rights such as utility-model registrations, inventor(s) certificates, and the like), heretofore or hereafter filed for said improvements in any foreign countries, and all patents (including all extensions, renewals, and reissues thereof) granted for said improvements in any foreign countries; and I/WE hereby authorize and request the United States Commissioner of Patents and Trademarks, and any officials of foreign countries whose duty it is to issue patents on applications as aforesaid, to issue all patents for said improvements to Assignee in accordance with the terms of this assignment.

Each of the undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue said Letters Patents to Assignee.

Each of the undersigned hereby authorizes the attorneys of record in said application to insert in this assignment the filing date and serial number of said application when officially known.

Each of the undersigned warrants himself/herself to be the owner of the entire right, title and interest in said invention or improvements and to have the full right to make this assignment, and further warrants that there are no outstanding prior assignments, licenses, or other encumbrances on the interest herein assigned, and will not execute any agreement in conflict herewith;

AND I/WE HEREBY further covenant and agree that I/WE will communicate to Assignee any facts known to me/us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, continuations-in-part, re-examination, extension, substitute and reissue applications, make all rightful oaths, and generally do everything possible to aid Assignee to obtain and enforce proper patent protection for said improvements in all countries.

I hereunto set my hand this 23rd day of April, 2014.



TIMOTHY D. HENSON

I hereunto set my hand this 23rd day of April, 2014.



KAPIL KELKAR

I hereunto set my hand this _____ day of _____, 20__.

LJUBO RADIC

ASSIGNMENT

WHEREAS, I/WE:

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Timothy D. Henson	2003 Gramercy Ave.; Torrance, CA 90501
Kapil Kelkar	2740 Gramercy Ave., Unit#10; Torrance, CA 90501
Ljubo Radic	2029 W 182nd St.; Torrance, CA 90504

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I hereunto set my hand this _____ day of _____, 20__.

TIMOTHY D. HENSON

I hereunto set my hand this _____ day of _____, 20__.

KAPIL KELKAR

I hereunto set my hand this 21st day of April, 2014__.

/Ljubo Radic/
LJUBO RADIC